PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company STMicroelectronics International N.V		STMicroelectronics International N.V
1.2 PCN No.		AMG/17/10638
1.3 Title of PCN		TSMC Taiwan as additional FE plant for the listed products: LSM6DS3TR-C- LSM6DSDTR-LSM6DSETR-LSM6DSLUSTR-LSM6DSMUSTR- ISM330DLCTR.
1.4 Product Category		See product list
1.5 Issue date		2017-12-22

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	MARCELI SMIALKOWSKI	
2.1.2 Phone	+44 1628896277	
2.1.3 Email	marceli.smialkowski@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Andrea Mario ONETTI	
2.1.2 Marketing Manager	Simone FERRI	
2.1.3 Quality Manager	Michele CALDERONI	

3. Change			
3.1 Category	3.2 Type of change	3.3 Manufacturing Location	
	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Wafer fabrication	Agrate- Crolles- Rousset-TSMC (Taiwan)	

4. Description of change			
Old New			
4.1 Description	Agrate- Crolles- Rousset as FE plant.	TSMC (Taiwan) as Additional FE Plant.	
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact		

5. Reason / motivation for change		
	The request to have TSMC as additional FE Plant will increase the capacity production for the following products: LSM6DS3TR-C- LSM6DSDTR-LSM6DSETR-LSM6DSLTR-LSM6DSLUSTR-LSM6DSMUSTR- ISM330DLCTR.	
5.2 Customer Benefit	CAPACITY INCREASE	

6. Marking of parts / traceability of change		
6.1 Description	Dedicated FG codes	

7. Timing / schedule		
7.1 Date of qualification results	2018-03-31	
7.2 Intended start of delivery	2018-04-30	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)
10638 Public product.pdf

10. Affected parts			
10. 1 Current		10.2 New (if applicable)	
10.1.1 Customer Part No 10.1.2 Supplier Part No		10.1.2 Supplier Part No	
	LSM6DSLTR		

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